

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE 1

Applicant:

Orcutt, et al.

Docket No.:

TI-32675

Serial No.:

10/085,507

Confirm. No.:

TBD

Filed:

02/26/2002

Examiner:

TBD

Title:

Optical Wireless Network Printed Circuit Board Micromirror Assembly

Having In-Package Mirror Position Feedback

TRANSMITTAL OF FORMAL DRAWINGS

Assistant Commissioner of Patents Washington, DC 20231

Attention: Official Drafts Person

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8(a)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Comphission of For Patents, Washington, DC 20231.

Villiam B. Kempler, Rog No. 28,228

Date

Dear Sir:

Submitted herewith are <u>3</u> sheets of formal drawings.

Charge any necessary fee to Deposit Account No. 20-0668, Texas struments Incorporated. This authorization is enclosed in triplicate.

Respectfully submitted,

Texas Instruments Incorporated P. O. Box 655474, MS 3999 Dallas, Texas 75265

(972) 917-5452

Fax: (972) 917-4407

William B. Kempler

Senior Corporate Patents Counsel

Reg. No.: 28,228

BEST AVAILABLE COPY